

TOSHIBA Diode Silicon Epitaxial Planar Type

HN1D03FU

Ultra High Speed Switching Application

- AEC-Q101 Qualified (Note1)
- Built in anode common and cathode common.

Note1: For detail information, please contact our sales

Unit 1

- Low forward voltage Q1, Q2: $V_F(3) = 0.90\text{ V (typ.)}$
- Fast reverse recovery time Q1, Q2: $t_{rr} = 1.6\text{ ns (typ.)}$
- Small total capacitance Q1, Q2: $C_T = 0.9\text{ pF (typ.)}$

Unit 2

- Low forward voltage Q3, Q4: $V_F(3) = 0.92\text{ V (typ.)}$
- Fast reverse recovery time Q3, Q4: $t_{rr} = 1.6\text{ ns (typ.)}$
- Small total capacitance Q3, Q4: $C_T = 2.2\text{ pF (typ.)}$

Unit 1, Unit 2 Common Absolute Maximum Ratings
($T_a = 25^\circ\text{C}$)

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V_{RM}	85	V
Reverse voltage	V_R	80	V
Maximum (peak) forward current	I_{FM}	300 (*)	mA
Average forward current	I_O	100 (*)	mA
Surge current (10 ms)	I_{FSM}	2 (*)	A
Power dissipation	P_D (Note 4)	200	mW
Junction temperature	T_j (Note 2)	150	$^\circ\text{C}$
	T_j (Note 3)	125	
Storage temperature	T_{stg} (Note 2)	-55 to 150	$^\circ\text{C}$
	T_{stg} (Note 3)	-55 to 125	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

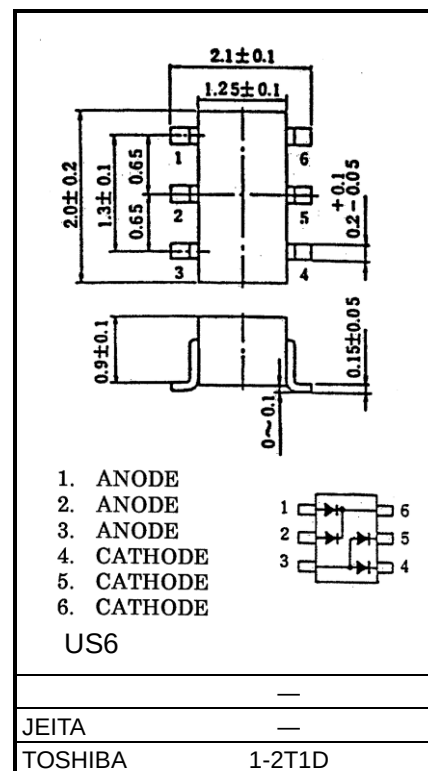
Note 2: For devices with the ordering part number ending in LF(T).

Note 3: For devices with the ordering part number in other than LF(T).

Note 4: Total rating, Mounted on a FR4 board. (25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 0.32 mm² × 6).

(*) These are the Absolute Maximum Ratings for a single diode (Q1 or Q2 or Q3 or Q4). If Unit 1 and Unit 2 are used independently or simultaneously, the Absolute Maximum Ratings per diode are 75% of those of a single diode.

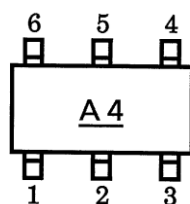
Unit: mm



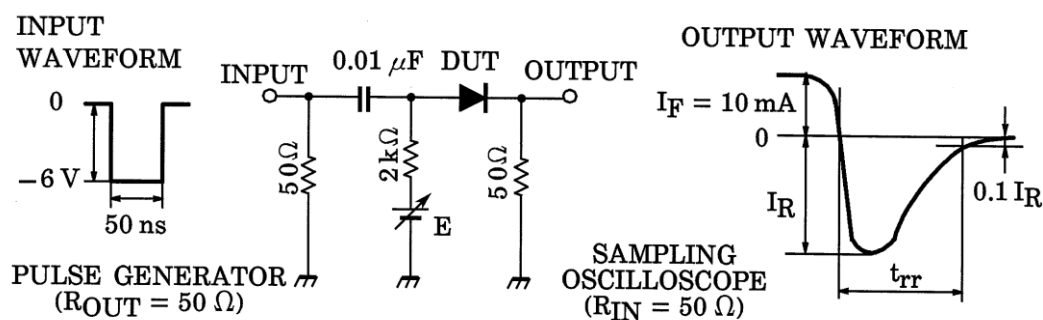
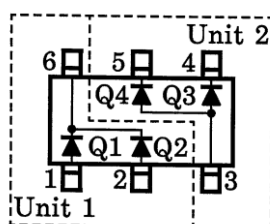
Weight: 6.2mg (typ.)

Start of commercial production
1992-05

Marking



Pin Assignment (Top View)

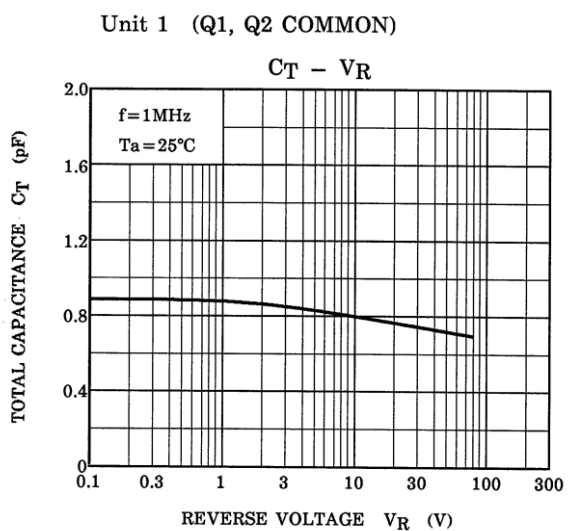
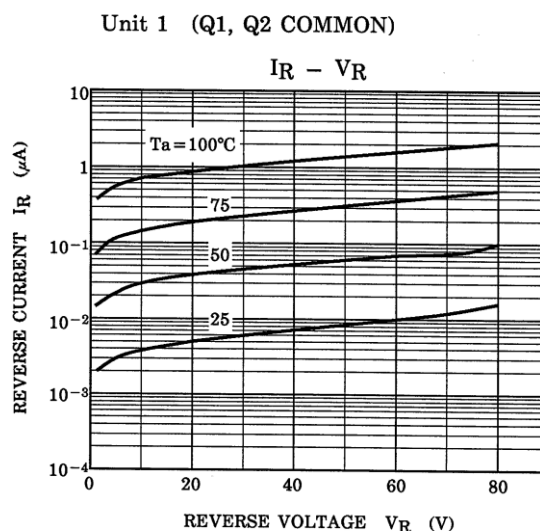
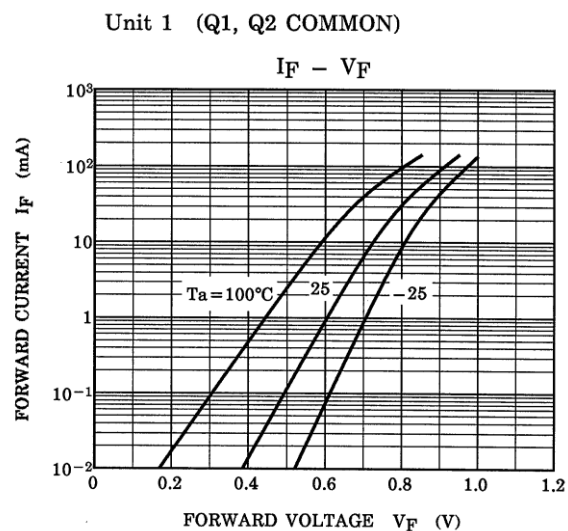
Fig.1 Reverse Recovery Time (t_{rr}) Test CircuitUnit 1 Electrical Characteristics (Q1, Q2 Common) ($T_a = 25^\circ\text{C}$)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Forward voltage	V_F (1)	—	$I_F = 1 \text{ mA}$	—	0.60	—	V
	V_F (2)	—	$I_F = 10 \text{ mA}$	—	0.72	—	
	V_F (3)	—	$I_F = 100 \text{ mA}$	—	0.90	1.20	
Reverse current	I_R (1)	—	$V_R = 30 \text{ V}$	—	—	0.1	μA
	I_R (2)	—	$V_R = 80 \text{ V}$	—	—	0.5	
Total capacitance	C_T	—	$V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$	—	0.9	3.0	pF
Reverse recovery time	t_{rr}	—	$I_F = 10 \text{ mA}$ (fig.1)	—	1.6	4.0	ns

Unit 2 Electrical Characteristics (Q3, Q4 Common) ($T_a = 25^\circ\text{C}$)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Forward voltage	V_F (1)	—	$I_F = 1 \text{ mA}$	—	0.61	—	V
	V_F (2)	—	$I_F = 10 \text{ mA}$	—	0.74	—	
	V_F (3)	—	$I_F = 100 \text{ mA}$	—	0.92	1.20	
Reverse current	I_R (1)	—	$V_R = 30 \text{ V}$	—	—	0.1	μA
	I_R (2)	—	$V_R = 80 \text{ V}$	—	—	0.5	
Total capacitance	C_T	—	$V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$	—	2.2	4.0	pF
Reverse recovery time	t_{rr}	—	$I_F = 10 \text{ mA}$ (fig.1)	—	1.6	4.0	ns

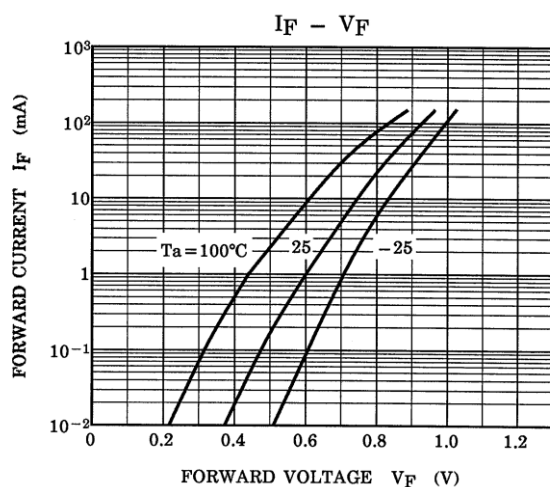
Characteristics Curves



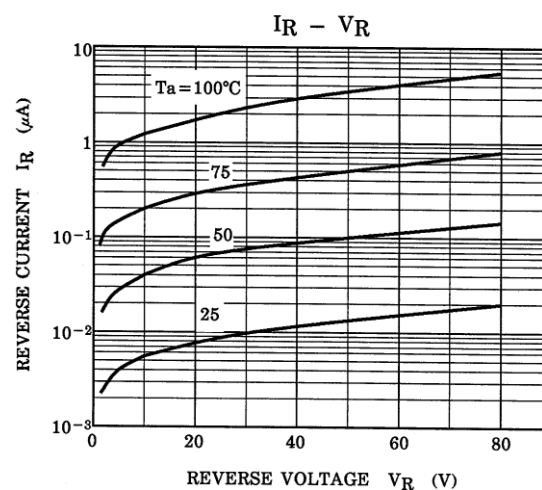
The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Characteristics Curves

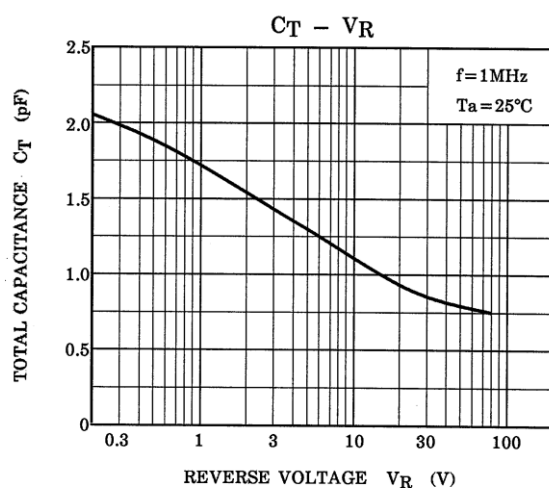
Unit 2 (Q3, Q4 COMMON)



Unit 2 (Q3, Q4 COMMON)



Unit 2 (Q3, Q4 COMMON)



The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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